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ENVIRONMENTALLY FRIENDLY PACKAGING

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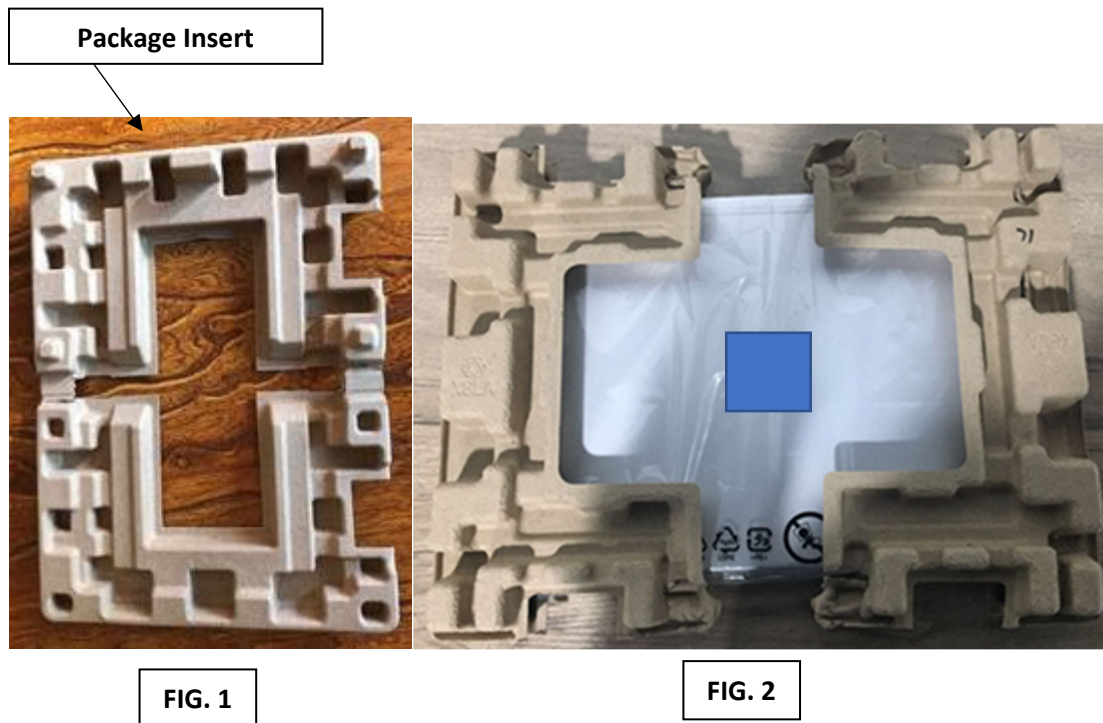


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Environmentally Friendly Packaging

A package insert (e.g., FIG. 1 and FIG. 2) may be used for electronic packaging (e.g., computers, monitors, etc.). The package insert may be made from molded pulp. The pulp may be made from a paper plastic film. The entire surface of the package insert may be coated with a layer of varnish.



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